

Ultra high power carbon-based micro-supercapacitors

Magali Brunet, David Pech, Hugo Durou, Peihua Huang

*Laboratoire d'Analyse et d'Architecture des Systèmes,
CNRS, Université de Toulouse*



Pierre-Louis Taberna, Patrice Simon
CIRIMAT, CNRS, Université de Toulouse



Yury Gogotsi, Vadym Mochalin, Min Heon

A.J. Drexel Nanotechnology Institute, Drexel University, Philadelphia

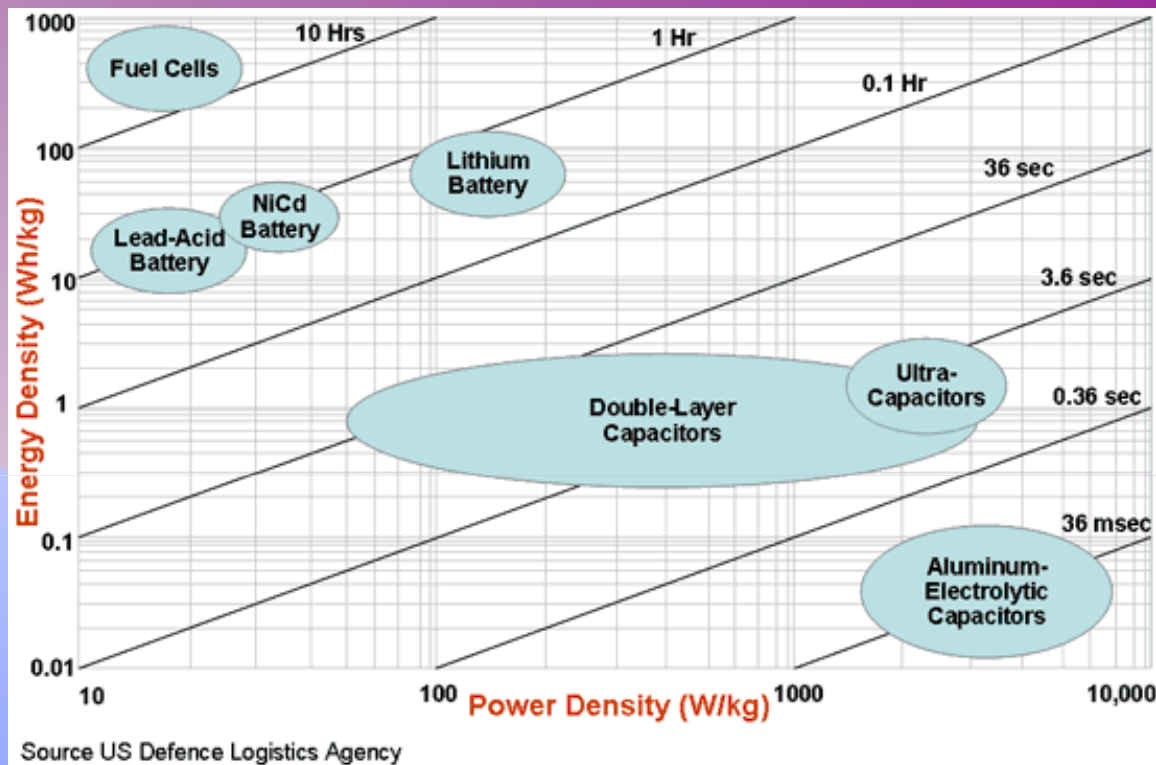
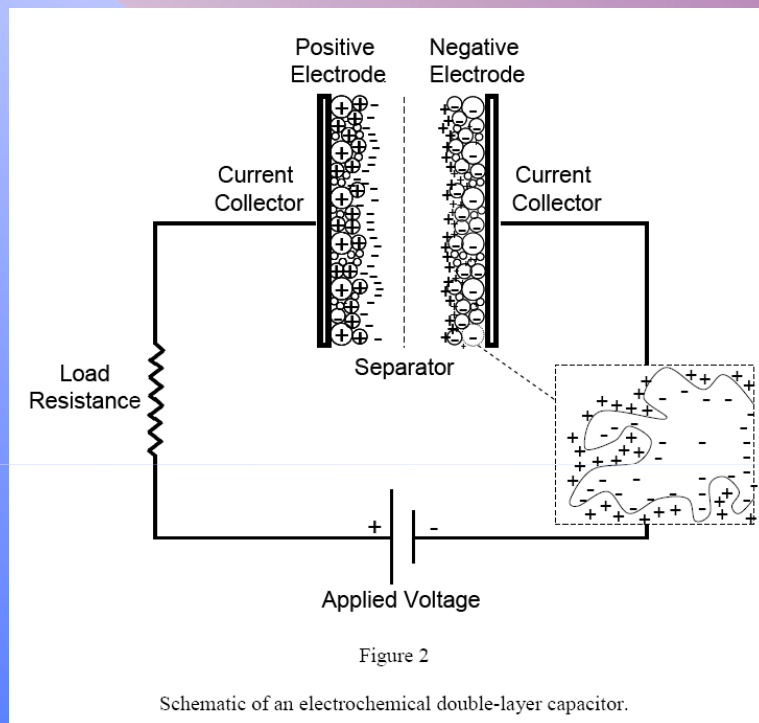


Outline

- Context:
 - Supercapacitors: principles and applications
 - Practical application: Autonomous Wireless Sensors Networks
 - Why micro-scale energy storage ?
 - State of the Art in micro-supercapacitors
- Ultra-high power carbon based micro-supercapacitors:
 - Technology + materials
 - Performance
 - Comparison with 3D capacitors
- Conclusions and perspectives

Supercapacitors

• Electrochemical Double Layer Capacitors



• Pseudo-capacitors:

- Metal oxides: RuO_2 , MnO_2
- Conducting polymers: PPy

		Material			Cell
		Density (g/cm ³)	C (F/g)	C (F/cm ³)	C (F/cm ³)
Activated Carbon	Organic (2.5 V)	0,7	100 - 200	70 - 140	17.5 – 35
Hydrous RuO_2	Sulfuric acid (1V)	2	650	1300	325

Typical applications

Loading /unloading container ships:
Captures and stores regenerative energy during load;
fuel saving of 40%



Tools: cutters, screw drivers...



Power
Watt

Portable electronics:
Memory maintenance
Battery auxiliary for power boosts

mWatt

Self-powered applications...

MWatt

Transport:

- buses, tramways
- Hybrid cars

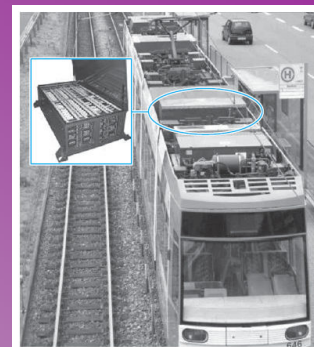
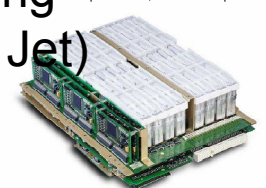


Figure 20 - Système MITRAC utilisant les supercondensateurs pour le stockage de l'énergie.

Emergency door opening
(AIRBUS A380 Jumbo Jet)



- Advantages by using Ultracaps
- Low weight
 - Excellent life time due to high cycle number
 - High reliability
 - No maintenance



Self Powered Applications

Increasing needs for self-powered applications

(nomad electronics, wireless sensors network, active RFID, biosensors, implanted microsystems...)

Embedded systems with a complete autonomy of energy

Energy scavenging
and harvesting

*photovoltaic, thermoelectric,
piézoélectrique, electromagnetic*



Energy storage
and management



Applications

Technological problems



Microbatteries

+ *Temperature range, Integration, Pollution...*

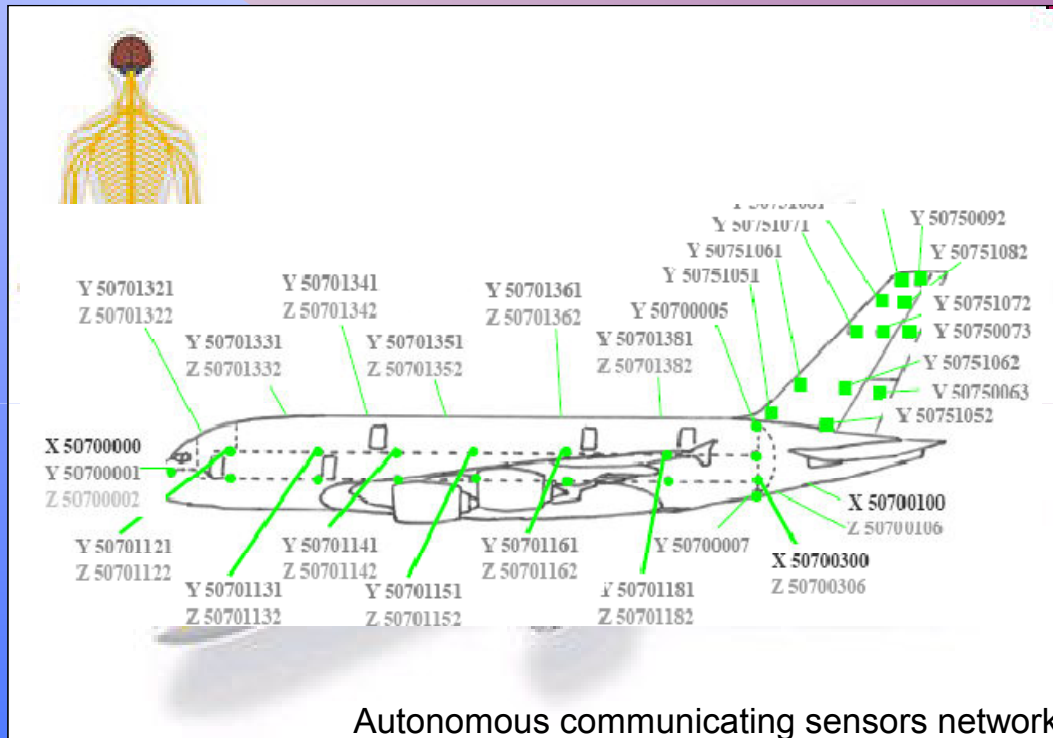
- **Limited lifetime**
(→ restriction on the autonomy of the whole system)
- **Low power density**



Energy storage in supercapacitors

Autonomous Wireless Sensors Network (WSN) for aircraft structural monitoring

Structural Health Monitoring (SHM)



(Partnership with Airbus)

On board sensors to detect cracks, corrosion, delamination, and other damages

→ Reduce inspection costs

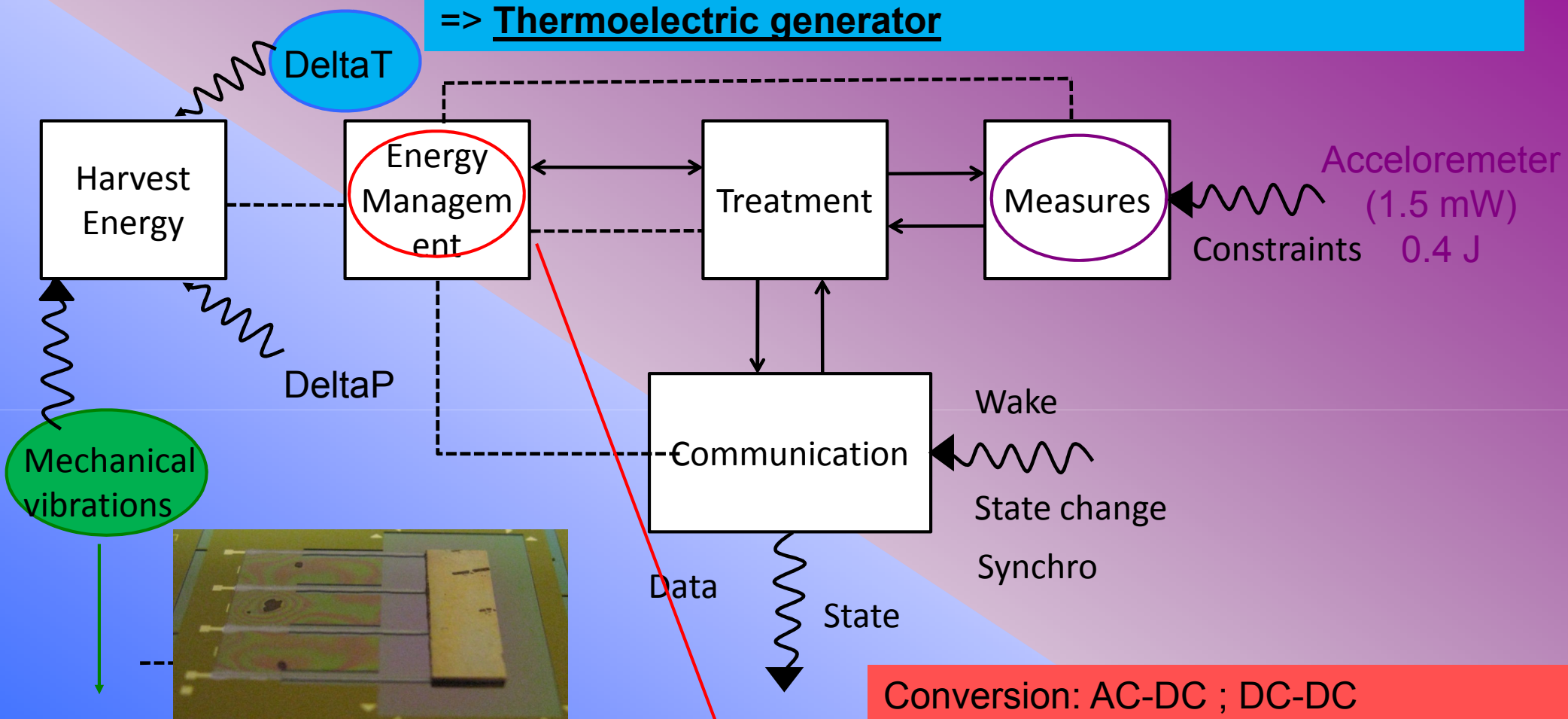
→ Increase safety

Specifications for in flight measurement :

- Temperature : **-50°C / +85°C**
- Lifetime : **40 years ; 5000h/year**
- High power uptake / delivery required
- Node thickness **< 5mm**

Practical example: AutoSENS project

Take off: Ground = $+40^{\circ}\text{C}$ to -20°C $\Rightarrow$ 12000 m = -60°C
 $\Rightarrow$ **Thermoelectric generator**



Take off $\Rightarrow 1\text{m.s}^{-2}@ 50\text{ Hz}$
 Cruise $\Rightarrow 0.1\text{m.s}^{-2}@ 50\text{ Hz}$
 $\Rightarrow$ **Piezoelectric generator**

Conversion: AC-DC ; DC-DC

Storage: **supercapacitors** (90 mF/cm^2)

Carbon (life time)

Organic electrolyte (temperature range)

Why micro-scale ?

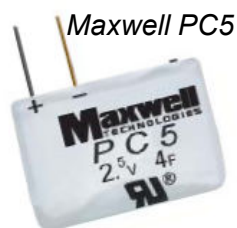
Short term :

- Monolithic integration
- Local storage for MEMS type devices (energy harvesting, sensors)
= minimisation of connections

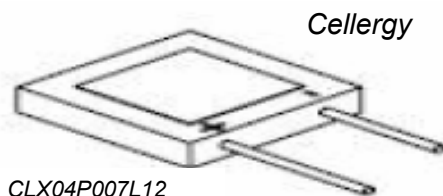
Long term :

- Large scale fabrication = low cost, reliability
- Enhancement of performance: energy and power densities
 - *Better accessibility to ionic species*
 - *Optimal use of active material : Surface / Volume* ↗

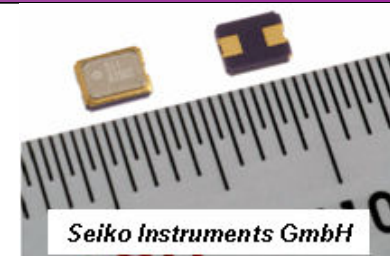
• Commercial devices



14 mm x 23.6 mm x 4.8 mm
C = 4 F – 2.5 V



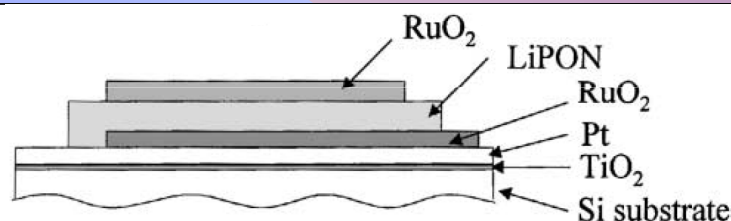
12 mm x 12.5 mm x 2 mm
C = 7 mF – 4.2 V



3.2 mm x 2.5 mm x 0.9 mm
C = 14 mF – 2.6 V

• Metals oxides

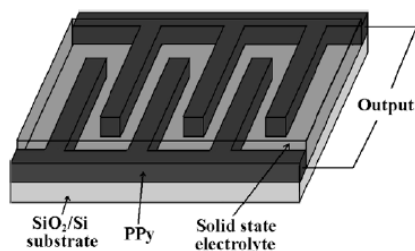
All solid-state
RuO₂ + LiPON



Y.S. Yoon *et al.*, J. Power Sources 101 (2001) 12 &
J. Electroceram. 17 (2006) 639.

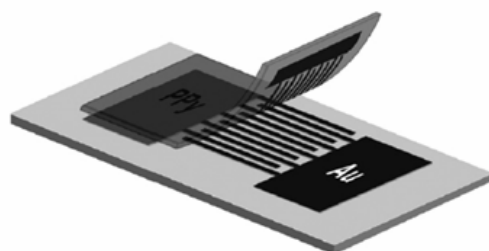
• Conducting polymers (Polypyrrole)

Interdigital – 50 μm



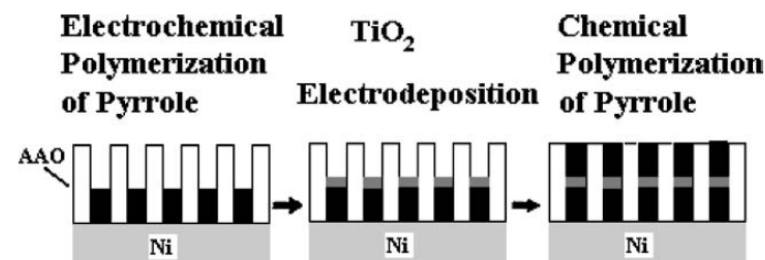
W. Sun & X. Chen, Microelectron. Eng. 86 (2009) 1307.

Flexible μ-supercapacitors



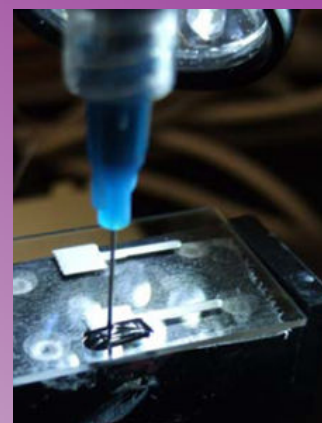
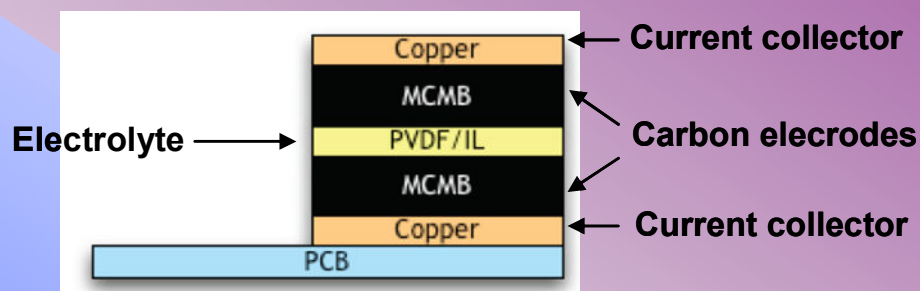
J.H. Sung *et al.*, J. Power Sources 162 (2006) 1467.

AAO template



L. Liu *et al.*, J. Solid St. Electrochem. 11 (2006) 32.

- Dispenser Printing on PCB (Berkeley Univ., US)



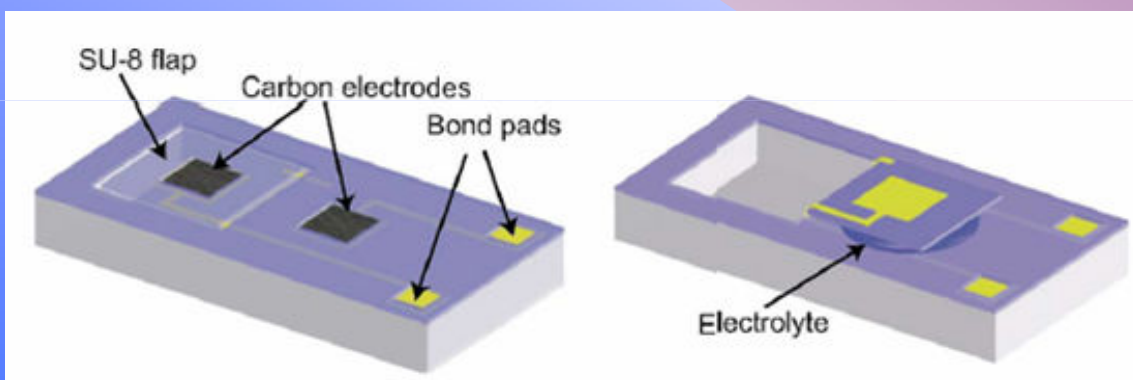
5 mm x 5 mm x 100 μ m

$C = 0.1 \text{ mF/cm}^2$

2 V

C.C. Ho *et al.*, PowerMEMS 2006.

- Probe tip deposition + Origami™ process (MIT, US)



350 μ m x 350 μ m x 40 μ m

$C = 0.4 \text{ mF/cm}^2$

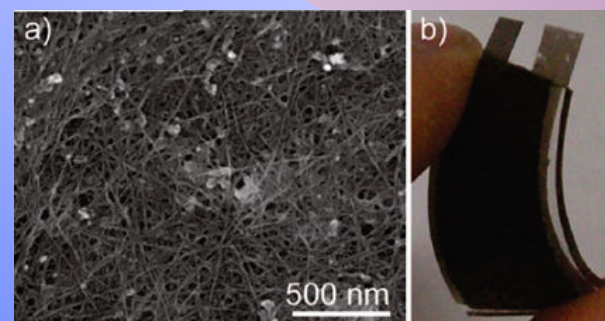
0.6 V

H.J. In *et al.*, Appl. Phys. Lett. 88 (2006) 083104.

- Printable Micro-Supercapacitor using SWCNT (Stanford Univ., US)

Solid Electrolyte : PVA / $\text{H}_3\text{PO}_4 \rightarrow$ (water-based)

M. Kaempgen *et al.*, Nano Letters 9 (2009) 1872.

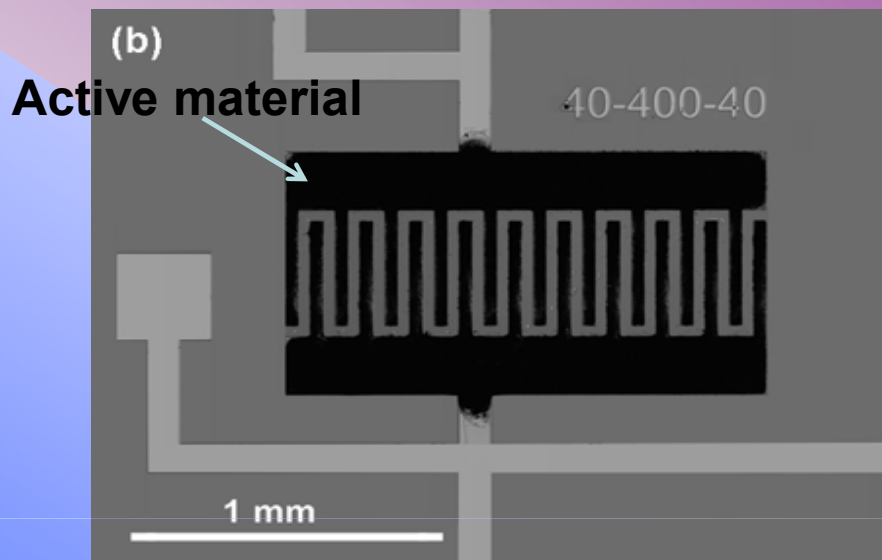


$\sim 10 \text{ } \mu\text{m}$ thick

$C = 1.2 \text{ mF/cm}^2$

1 V

- Inkjet printing (LAAS-CNRS, France)



Width: **40 μm** – Length : **400 μm** – Interspace : **40 μm**
Thickness: 1-2 μm (0.64 mm² / electrode)

400 μm x 600 μm x 2 μm

$C = 2.1 \text{ mF/cm}^2$

2.5 V

$E = 6,6 \text{ mJ/cm}^2$

$P = 44,9 \text{ mW/cm}^2$

D. Pech, M. Brunet, P-L Taberna, P. Simon, N. Fabre, F. Mesnilgrete, V. Conédéra, H. Durou, *Journal of Power Sources* 195 (2010) 1266.

Pros:

→ High resolution

Cons:

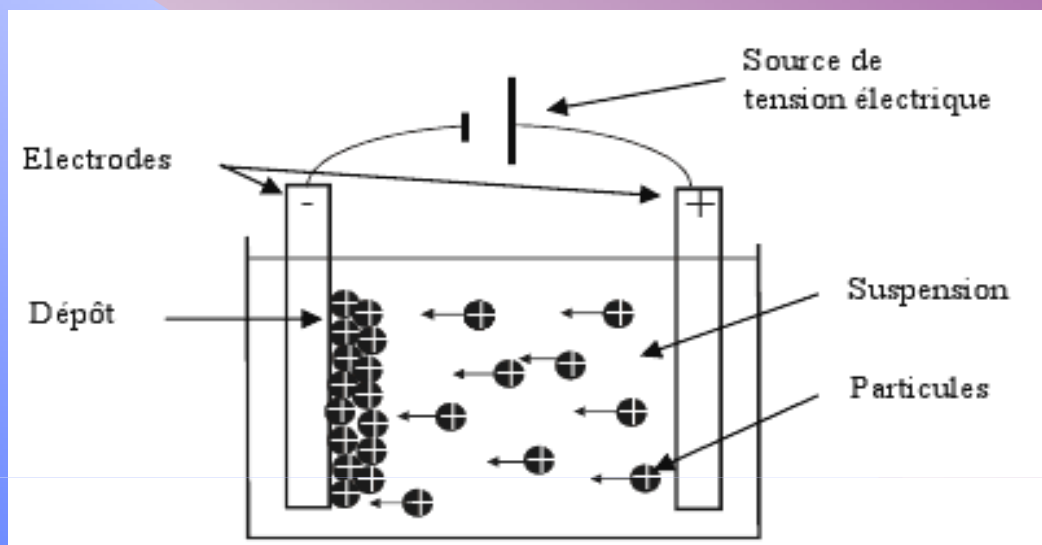
⇒ Limited thickness

⇒ Emulsion stability difficult

Outline

- Context:
 - Supercapacitors: principles and applications
 - Practical application: Autonomous Wireless Sensors Networks
 - Why micro-scale energy storage ?
 - State of the Art in micro-supercapacitors
- Ultra-high power carbon based micro-supercapacitors:
 - Technology + materials
 - Performance
 - Comparison with 3D capacitors
- Conclusions and perspectives

Principles : *Charged particles in suspension migrating under potential*

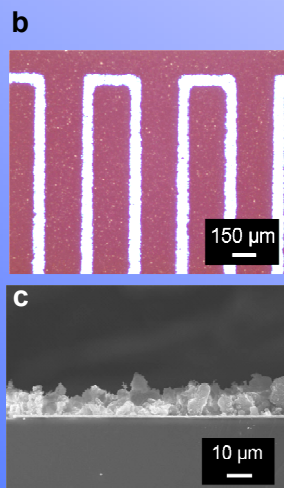
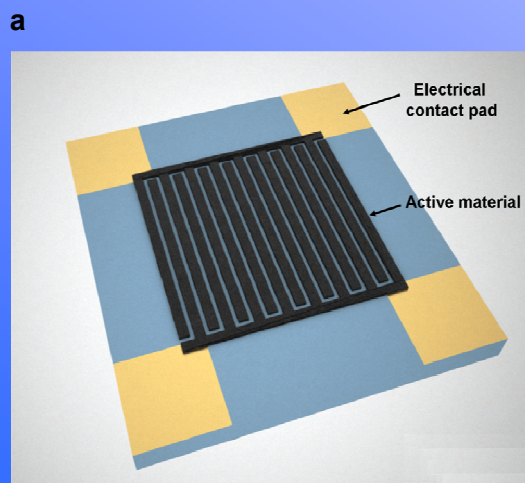


Experimental :

95 vol.% ethanol – 5 vol.% water

0,3 wt.% of carbon

MgCl₂ : 10 wt.% (charges + ligant)



Pros :

- Adhesive and dense films
- Collective deposition
- Thickness => 80 μm

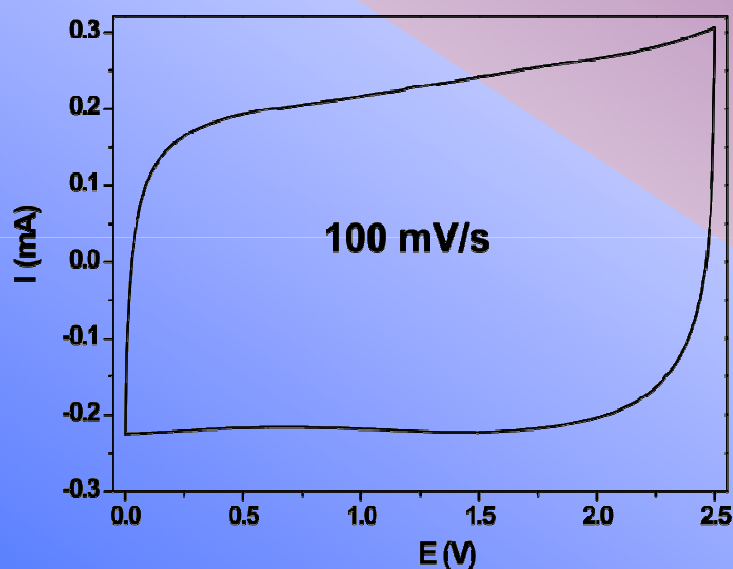
Cons :

Limited resolution : 50 μm (can be improved)

Results with activated carbon

YP-50F (1700 m²/g)

Tests in 1M Et₄NBF₄/anhydrous propylene carbonate electrolyte in a glove box



Thickness = 5 μ m

C = 18 mF/cm²

(4.5 mF)

E = 23,9 mJ/cm²

P = 506 mW/cm²

Dimensions	Potential window	Electrode Capacitance	Institution
25 mm ²	2 V	0.5 mF/cm ²	Berkeley
0.12 mm ²	0.6 V	1.6 mF/cm ²	MIT
-	1 V	4.8 mF/cm ²	Stanford
25 mm ²	2.5 V	18 mF/cm²	LAAS

Results with OLC

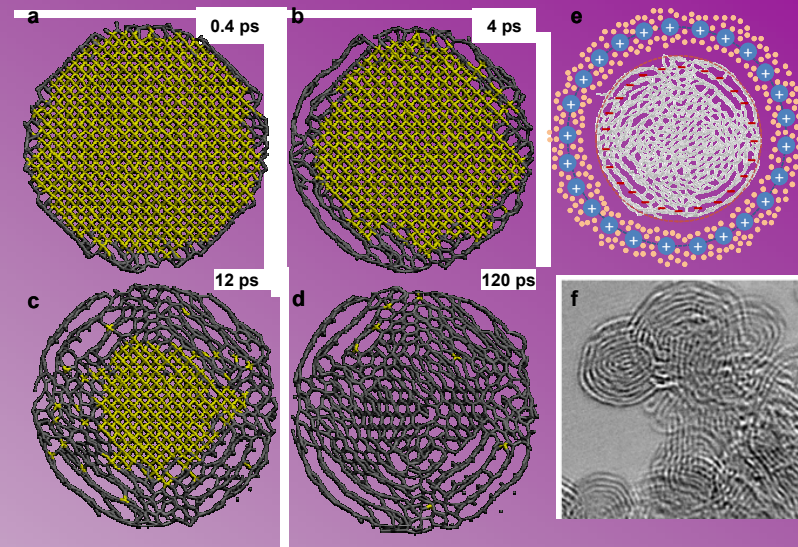
OLC = Onion Like Carbon (*Drexel University*)

From annealing of nanodiamonds at 1800°C under vacuum

- 520 m²/g

- Pore size = 6 nm

Osswald, S., Yushin, G., Mochalin, V., Kucheyev, S.O. & Gogotsi, Y. *J. Am. Chem. Soc.* **128**, 11635-11642 (2006).

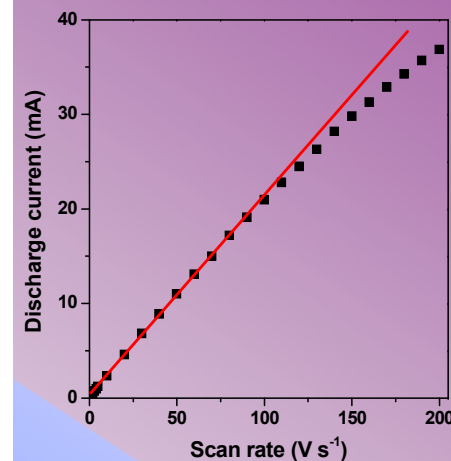
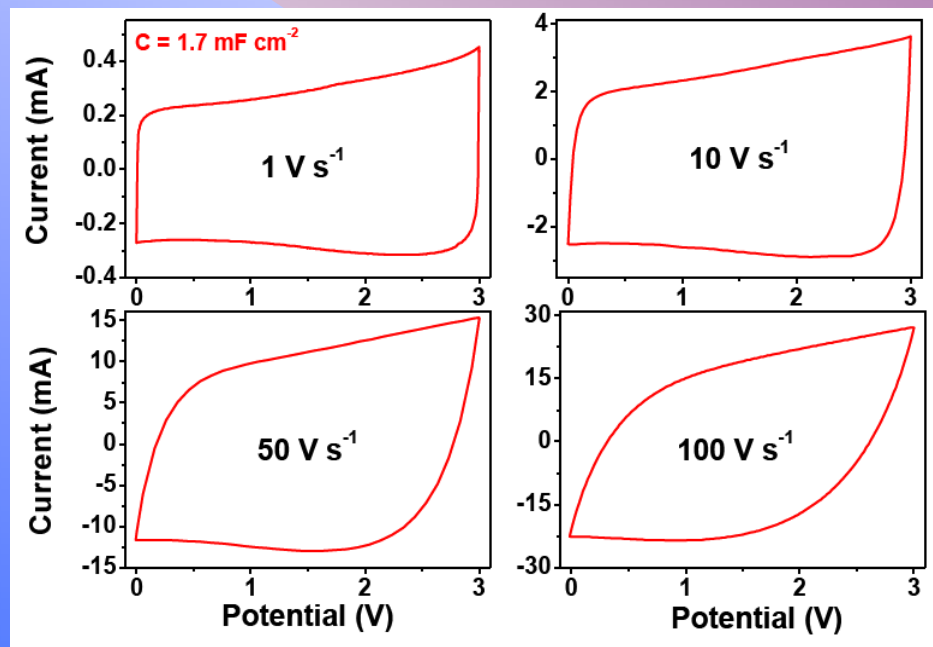


Thickness = 7 μm

$C = 0,258 \text{ mF}$
 $= 1.7 \text{ mF/cm}^2$

$E = 4.6 \text{ mJ/cm}^2$

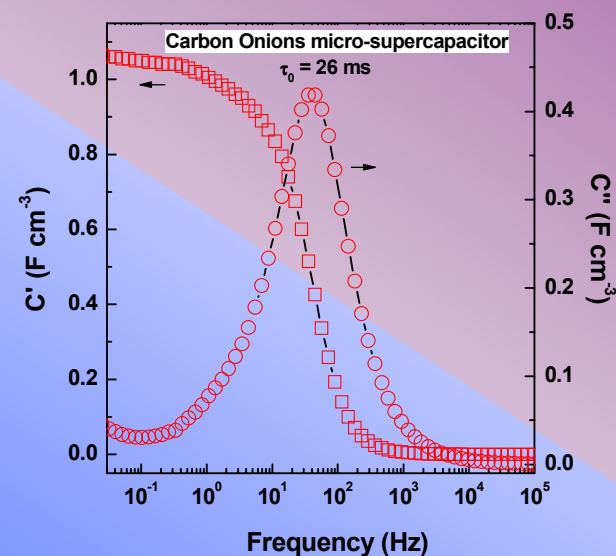
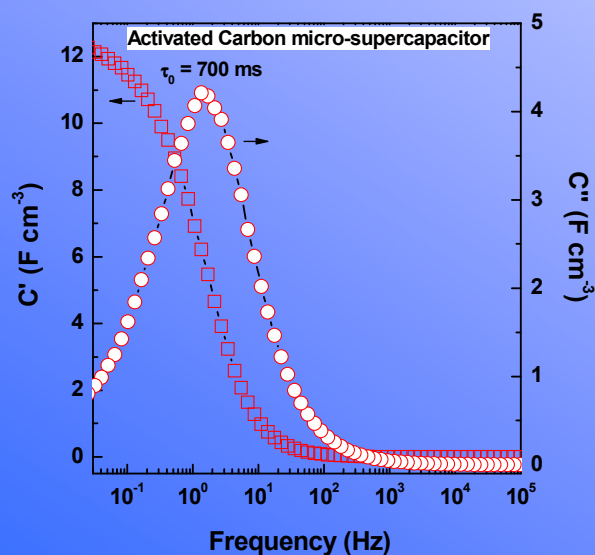
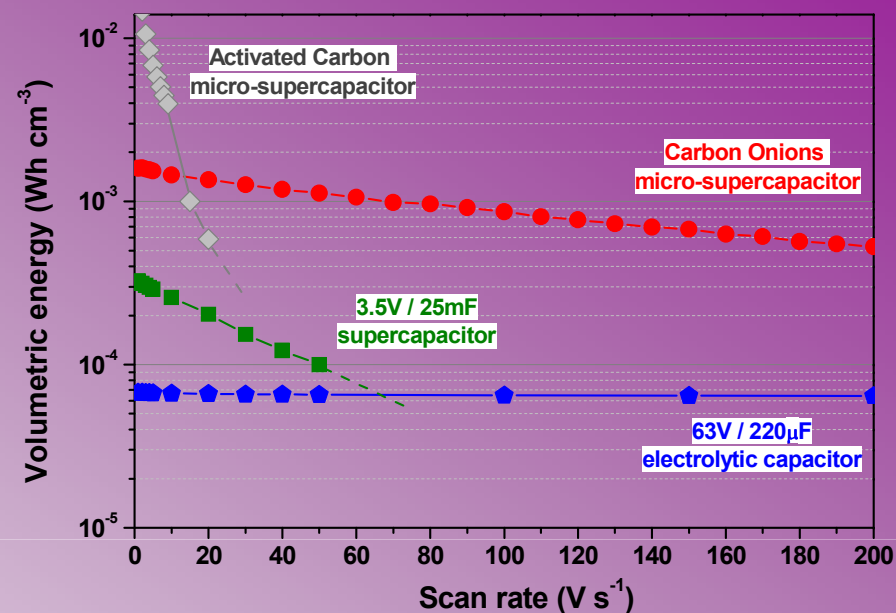
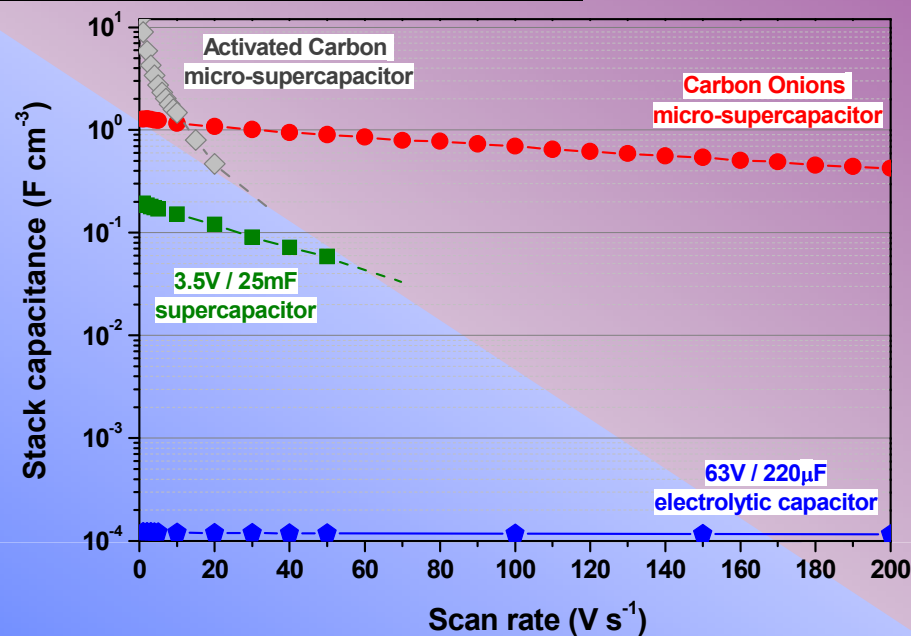
$P = 592 \text{ mW/cm}^2$



D. Pech, M. Brunet, et al., *Nature Nanotechnology* 9 (2010) 651

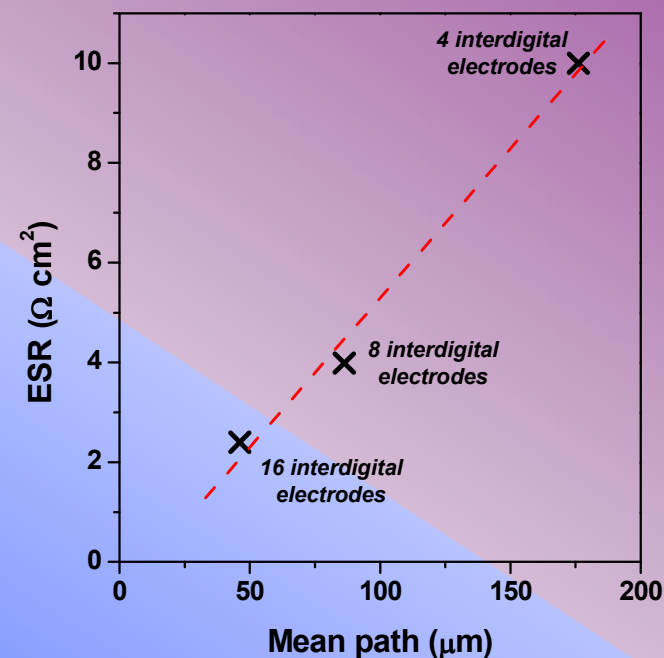
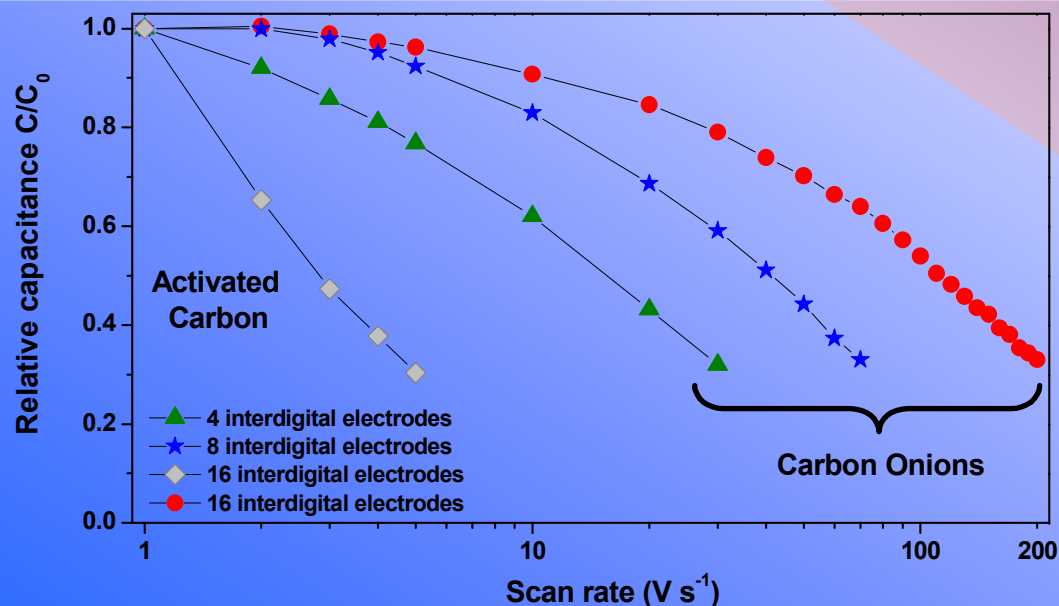
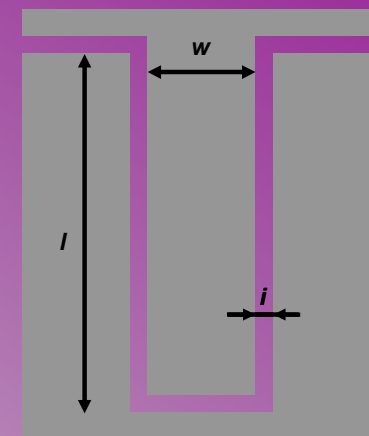
PwrSoC'10 – Cork 14/10/2010 – Magali

Active material comparison:



Highlight on micro-scale effect:

Number of interdigital electrodes	4	8	16
Width, w (μm)	1175.0	537.5	218.8
Length, l (mm)	4.5	4.5	4.5
Interspace, i (μm)	100	100	100
Surface of the conducting electrodes (mm^2)	21.15	19.35	15.75
Mean path (μm)	176.1	86.3	46.1
Surface of the cell (mm^2)	25	25	25



μ-supercapacitors versus SoA

- Comparison with SoA μsupercapacitors:

$$E = \frac{1}{2} C(U_0^2 - U_f^2)$$

$$P_{\max} = \frac{U_0^2}{4R_s}$$

Institution	Type	Component Dimensions	Maxim voltage	Maximum Scan rate	Component capacitance	Specific capacitance	ESR	Energy	Power
		cm ²	V	V/sec	mF	mF/cm ²	Ω.cm ²	mJ/cm ²	mW/cm ²
Berkeley 2006	Dispenser	0,25	2	0,005	0,1	0,1	--	0,2	--
MIT 2006	Origami	0,0012	0,6	0,05	0,001	0,4	--	0,072	--
Berkeley2009	CNT forest	0,35	0,6	0,05	0,149	0,43	--	0,077	0,28
LAAS 2009	Inkjet	0,023	2,5	1	0,046	2		6	44,9
LAAS 2010	EPD - AC	0,25	3	1	1,33	5.7	4,4	23,9	506
LAAS 2010	EPD - OLC	0,25	3	200	0,258	1	3,8	4,64	592

–Energy : up to 2 orders of magnitude higher than SoA

–Power: 3 orders of magnitude higher than SoA

μ -supercapacitors versus 3D capacitors

- Can μ -supercap compete with 3D capacitors?

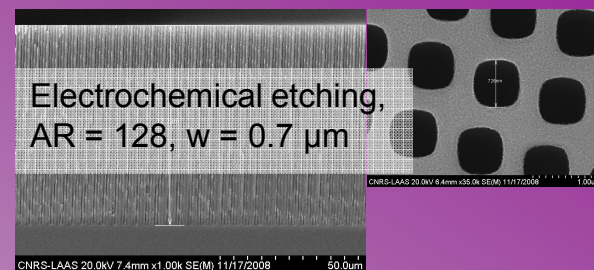
3D capacitors

Institution	Dimensions cm ²	Vmax	Capacitan mF/cm ²	ESR Ohm.cm ²	Energy mJ/cm ²	Power W/cm ²
LAAS 2006	4,90E-03	12	0,006	0,83m	0,44	43200
LAAS 2009	6,25E-04	8	0,065	6,88m	2,10	2330
NXP 2001	1,00E-01	30	0,003	14,5m	1,35	15500
NXP 2008	1,00E-04	6	0,044	1m	0,79	9000
Univ. Maryl	1,27E-04	4	0,1	1,27m	0,80	3160

μ -supercapacitors

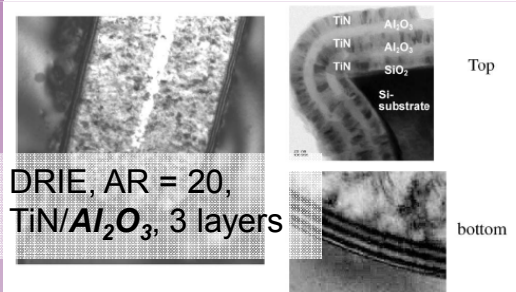
LAAS 2010	0,25	3	5.7	4,4	23,9	0,506
LAAS 2010	0,25	3	1	3,8	4,64	0,592

LAAS-CNRS



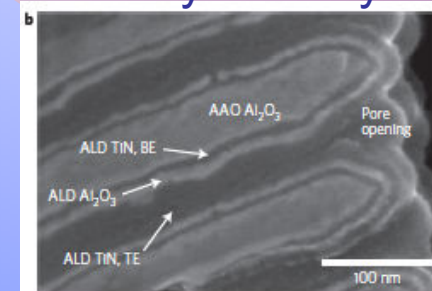
Brunet et al., MME 2009

NXP



Klootwijk, Roozeboom et al., EDL 2008

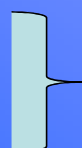
University of Maryland



Banerjee et al., Nature Nano 2009 19

– Advantages of 3D capacitors:

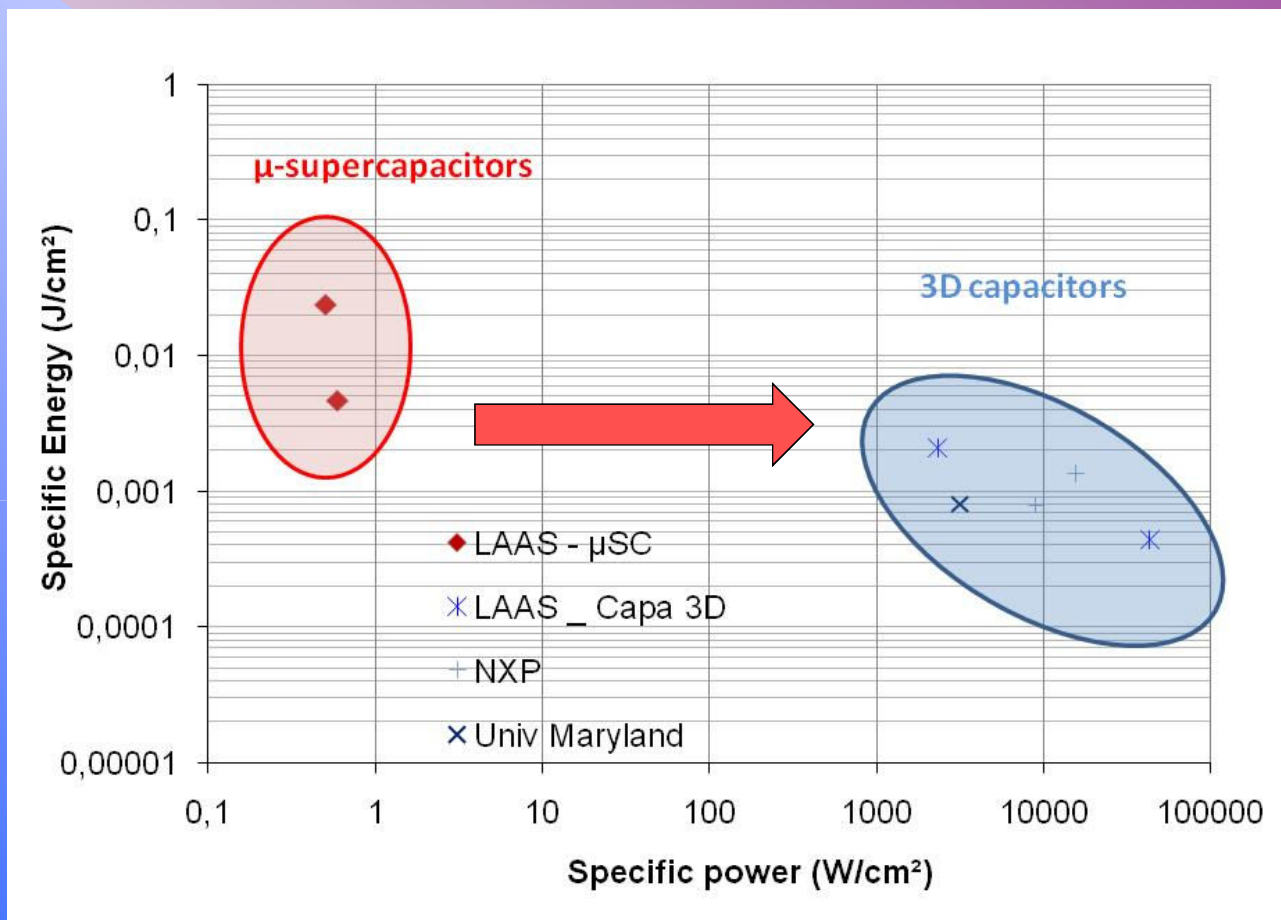
- Vmax
- ESR



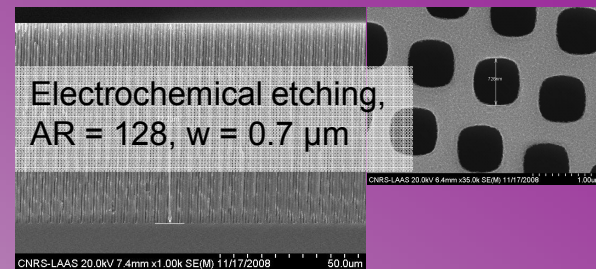
Power !

μ -supercapacitors versus 3D capacitors

- Can μ -supercap compete with 3D capacitors?

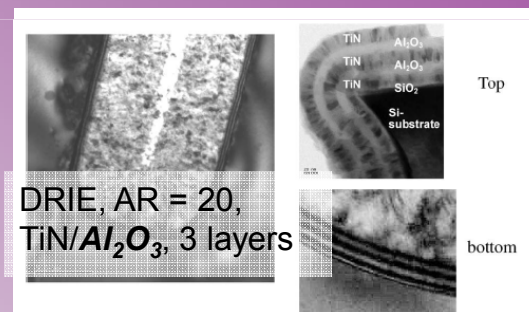


LAAS-CNRS



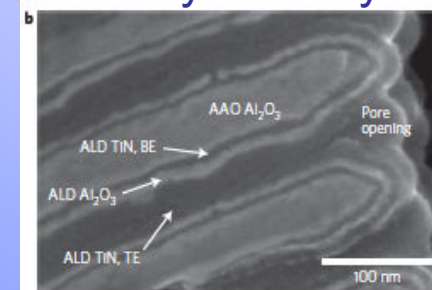
Brunet et al., MME 2009

NXP



Klootwijk, Roozeboom et al., EDL 2008

University of Maryland



Banerjee et al., Nature Nano 2009 20

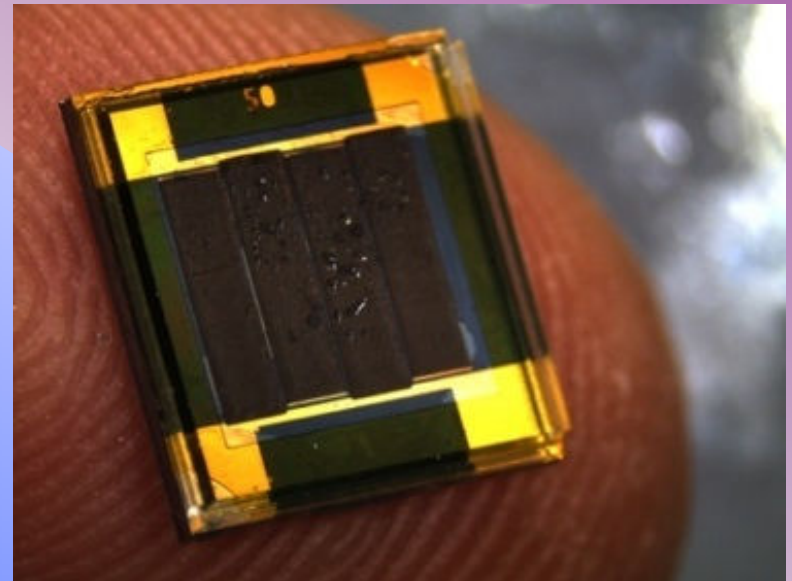
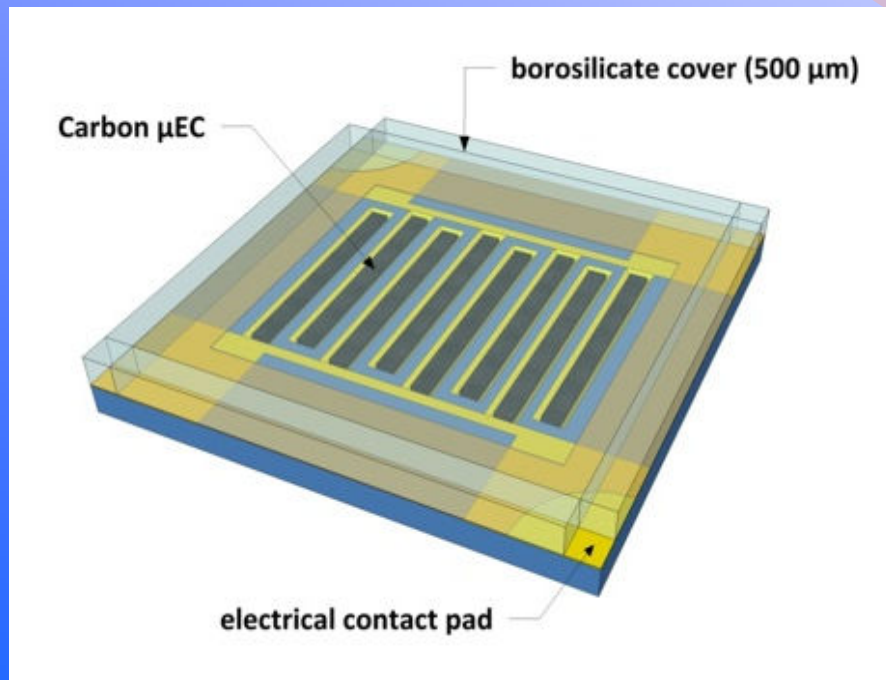
- Improve μ -supercap power:
 - Reduce ESR through improved design / electrolyte / material
 - Increase voltage window : hybrid configuration ?

Encapsulation of liquid organic electrolyte

- Wafer-level packaging
- Low temperature process ($< 150^{\circ}\text{C}$)
- Water tightness: must be processed in glove box → 2.5V range with organic electrolytes

Process:

1. Cover lid: photosensitive glue on glass
2. Electrolyte deposition
3. Bonding
4. Two pass dicing for uncovering electrical contacts



- *Conclusions :*

- Enabled technologies for storage on-chip:
 - Electrophoretic deposition of active material
 - Liquid, water-tight, low temperature encapsulation
- Benefits of micro-scale and enhanced materials demonstrated
 - => Ultra-high power components

- *Perspectives:*

- *More power:*
 - Improved design: e.g. interspace down to nanoscale
 - Improved materials: OLC, CNT...etc
 - Improved electrolyte
- *More Energy:*
 - Thicker electrodes
- Test in real environment with energy harvesting microsystem, electronics, sensor

Acknowledgment

Technical:

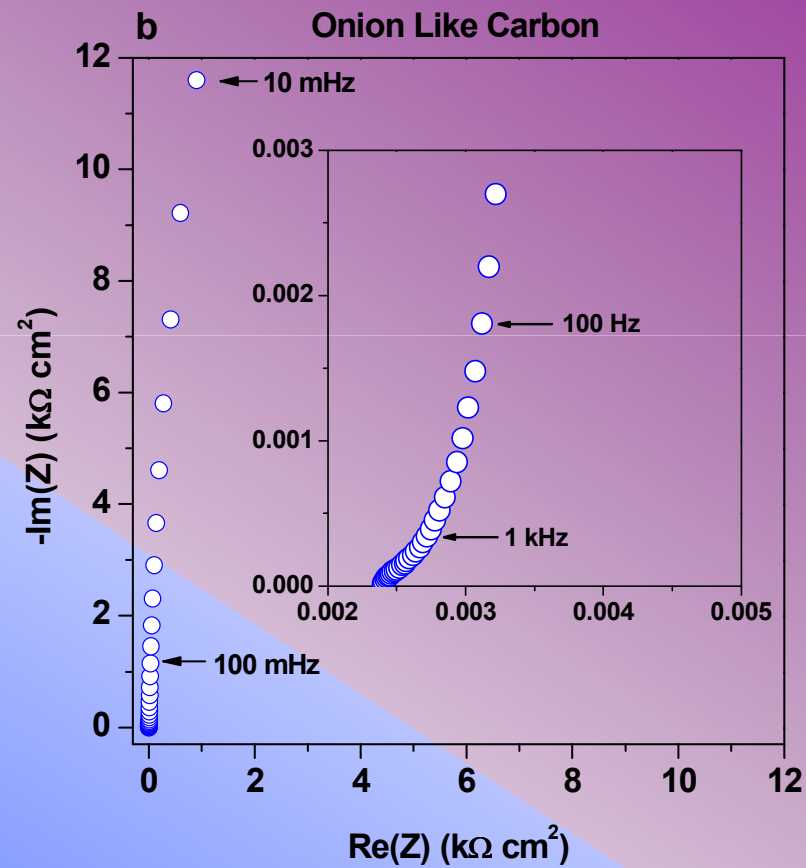
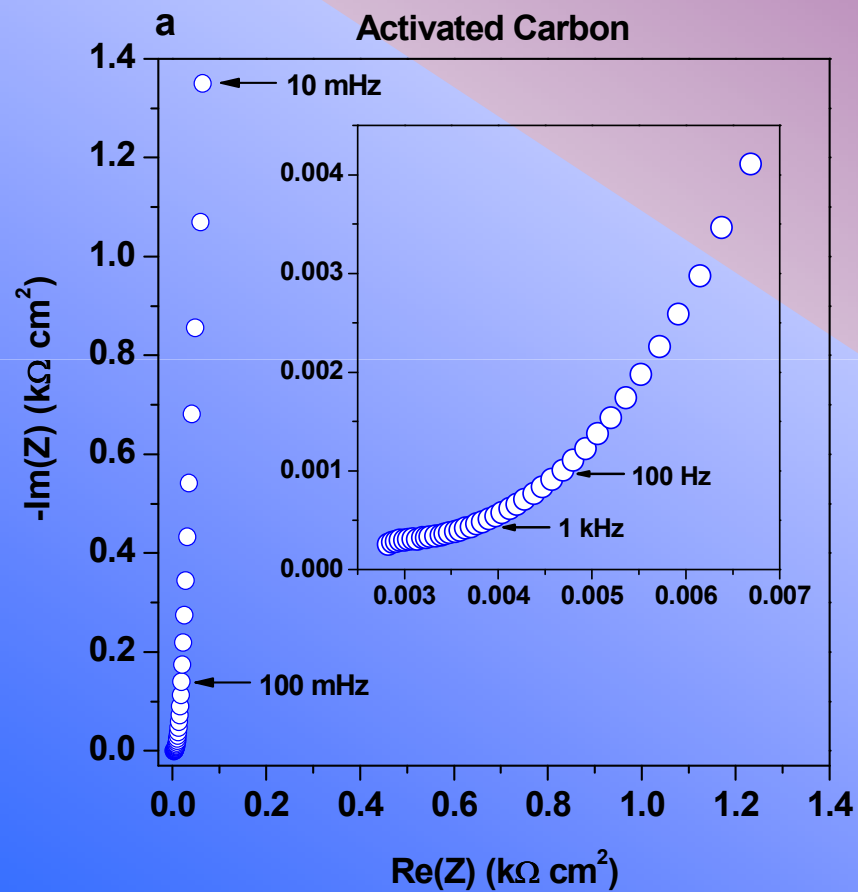
- Clean room facilities at LAAS-CNRS

Funding:

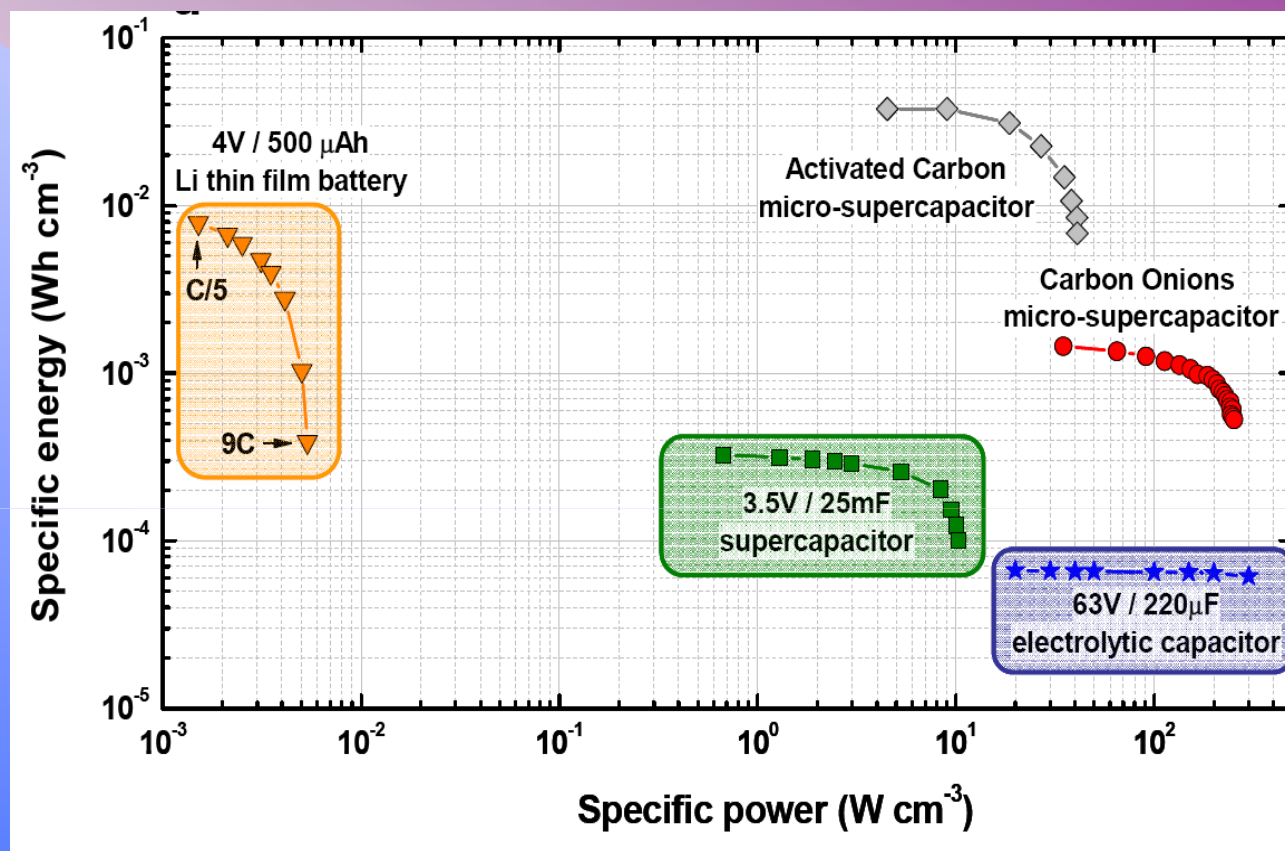
- Project **AUTOSENS** (Fondation de la Recherche Aéronautique et Espace)
- Projet **μsupercapacitors** (PUF:Partner University Fund, France- US exchange)

Thank you for your attention.

Nyquist plots



Comparison with macro-scale devices



Energy and Power by cm^3 of stack – Composants tested in dynamic conditions.

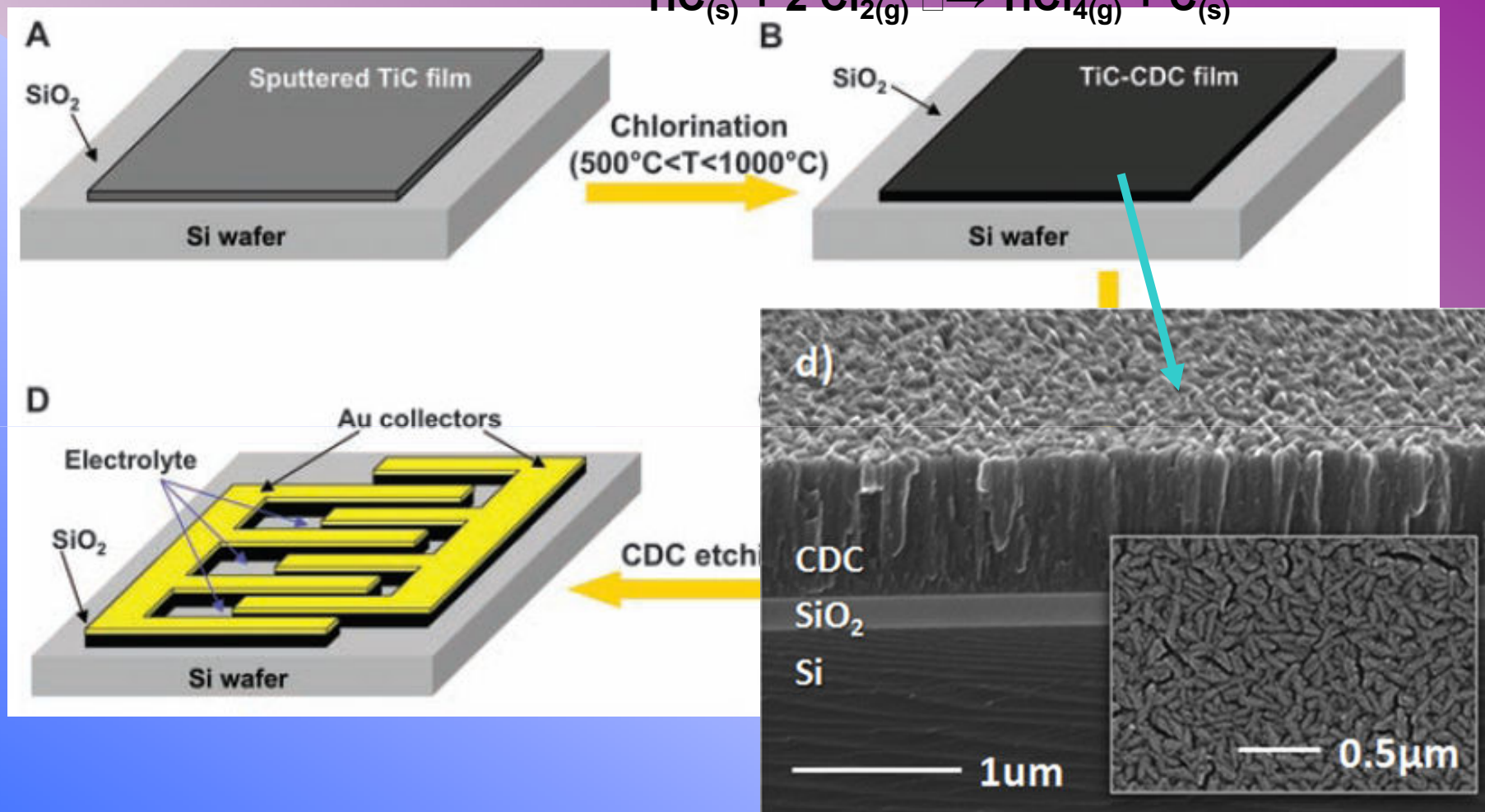
Conclusion:

High power densities reached thanks to enhanced nanostructured carbon + microstructured electrodes + no organic ligant

Componant	Leakage current	Charging time
Maxwell BCap 5F	3 $\mu\text{A}/\text{F}$	72 h @ 25 °C
Kanthal LK 1F	3,3 $\mu\text{A}/\text{F}$	70 h @ 25 °C
Panasonic Goldcap 1F	0,7 $\mu\text{A}/\text{F}$	150 h @ 25°C
CapXX HW207 0,4F	5 $\mu\text{A}/\text{F}$	70 h @ 25 °C

CDC (Carbide Derived Carbon)

(PhD. P. Huang)



- Technology adapted to micro-fabrication
- High density material: 180 F/cm³ (Activated carbon = 50 F/cm³)